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ON Semiconductor MJD18002D2T4G

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Bipolar NPN Transistor

High Speed, High Gain Bipolar NPN Power Transistor with Integrated Collector-Emitter Diode and Built-In Efficient Antisaturation Network

The MJD18002D2 is a state-of-the-art high speed, high gain bipolar transistor (H2BIP). Tight dynamic characteristics and lot to lot minimum spread (± 150 ns on storage time) make it ideally suitable for light ballast applications. Therefore, there is no longer a need to guarantee an $h_{\rm FE}$ window.

Features

- Low Base Drive Requirement
- High Peak DC Current Gain (55 Typical) @ I_C = 100 mA
- Extremely Low Storage Time Min/Max Guarantees Due to the H2BIP Structure which Minimizes the Spread
- Integrated Collector-Emitter Free Wheeling Diode
- Fully Characterized and Guaranteed Dynamic V_{CEsat}
- Characteristics Make It Suitable for PFC Application
- Epoxy Meets UL 94 V-0 @ 0.125 in
- ESD Ratings: Human Body Model, 3B > 8000 V
 Machine Model, C > 400 V
- Six Sigma® Process Providing Tight and Reproductible Parameter Spreads
- Pb-Free Package is Available

MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Collector-Emitter Sustaining Vo	Itage	V_{CEO}	450	Vdc
Collector-Base Breakdown Volt	age	V_{CBO}	1000	Vdc
Collector-Emitter Breakdown Vo	V_{CES}	1000	Vdc	
Emitter-Base Voltage	V_{EBO}	11	Vdc	
Collector Current - Continuo - Peak (No		I _C	2.0 5.0	Adc
Base Current - Continuo - Peak (No		I _B I _{BM}	1.0 2.0	Adc

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	50 0.4	W W/°C
Operating and Storage Temperature Range	T _J , T _{stg}	-65 to +150	°C
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	5.0	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	71.4	°C/W
Maximum Lead Temperature for Soldering Purposes: 1/8" from Case for 5 seconds	T _L	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Pulse Test: Pulse Width = 5.0 ms, Duty Cycle = 10%.



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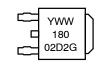
POWER TRANSISTOR 2 AMPERES 1000 VOLTS, 50 WATTS





DPAK CASE 369C STYLE 1

MARKING DIAGRAM



Y = Year WW = Work Week 18002D2 = Device Code G = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping [†]
MJD18002D2T4	DPAK	3000/Tape & Reel
MJD18002D2T4G	DPAK (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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MJD18002D2

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

Characteristic					Min	Тур	Max	Unit
OFF CHARACTERISTICS								
Collector–Emitter Sustaining Voltage (I _C = 100 mA, L = 25 mH)				V _{CEO(sus)}	450	570	-	Vdc
Collector-Base Breakdown Voltage (I _C	_{BO} = 1 mA)			V _{CBO}	1000	1100	-	Vdc
Emitter-Base Breakdown Voltage (I _{EB0}	_O = 1 mA)			V _{EBO}	11	14	-	Vdc
Collector Cutoff Current (V _{CE} = Rated	V_{CEO} , $I_B = 0$)			I _{CEO}	-	-	100	μAdc
Collector Cutoff Current ($V_{CE} = Rated$) ($V_{CE} = 500 \text{ V}, V_{EB} = 0$)	Collector Cutoff Current (V _{CE} = Rated V _{CES} , V _{EB} = 0)			I _{CES}	- - -	- - -	100 500 100	μAdc
Emitter-Cutoff Current (V _{EB} = 10 Vdc,	I _C = 0)		@ T _C = 125°C	I _{EBO}	_	_	500	μAdc
ON CHARACTERISTICS	<u> </u>			LDO	<u> </u>	I	I	· ·
Base-Emitter Saturation Voltage (I _C = 0.4 Adc, I _B = 40 mAdc) (I _C = 1.0 Adc, I _B = 0.2 Adc)			@ T _C = 25°C @ T _C = 25°C	V _{BE(sat)}	- -	0.78 0.87	1.0 1.1	Vdc
Collector–Emitter Saturation Voltage ($I_C = 0.4$ Adc, $I_B = 40$ mAdc)			@ T _C = 25°C @ T _C = 125°C	V _{CE(sat)}	- -	0.36 0.50	0.6 1.0	Vdc
$(I_C = 1.0 \text{ Adc}, I_B = 0.2 \text{ Adc})$			@ T _C = 25°C @ T _C = 125°C		-	0.40 0.65	0.75 1.2	
DC Current Gain ($I_C = 0.4$ Adc, $V_{CE} = 1.0$ Vdc)			@ T _C = 25°C @ T _C = 125°C	h _{FE}	14 8.0	25 15	- -	-
$(I_C = 1.0 \text{ Adc}, V_{CE} = 1.0 \text{ Vdc})$			@ T _C = 25°C @ T _C = 125°C		6.0 4.0	10 6.0	-	
DYNAMIC CHARACTERISTICS				•	•	•	•	
Current Gain Bandwidth (I _C = 0.5 Adc,	V _{CE} = 10 Vdc, f = 1	1 MHz)		f _t	_	13	-	MHz
Output Capacitance (V _{CB} = 10 Vdc, I _E	= 0, f = 1 MHz)			C _{ob}	-	50	100	pF
Input Capacitance (V _{EB} = 8 Vdc)				C _{ib}	-	340	500	pF
DIODE CHARACTERISTICS								
Forward Diode Voltage (I _{EC} = 1.0 Adc)			@ T _C = 25°C	V _{EC}	-	1.2	1.5	Vdc
(I _{EC} = 0.4 Adc)		@ T _C = 25°C		_	1.0	1.3		
			@ T _C = 125°C		_	0.6	-	
Forward Recovery Time (I _F = 0.4 Adc, di/dt = 10 A/ μ s)			@ T _C = 25°C	t _{fr}	-	517	_	ns
$(I_F = 1.0 \text{ Adc, di/dt} = 10 \text{ A/}\mu\text{s})$			@ T _C = 25°C		_	480	_	
DYNAMIC SATURATION VOLTAGE								
Dynamic Saturation Voltage	I _C = 0.4 Adc I _{B1} = 40 mA	@ 1 μs	@ T _C = 25°C	V _{CE(dsat)}	-	7.4	-	V
Determinated 1 μs and 3 μs	V _{CC} = 300 Vdc	@ 3 μs	@ T _C = 25°C		-	2.5	-	
respectively after rising I _{B1} reaches 90% of final I _{B1}	I _C = 1 Adc @ 1 μ		@ T _C = 25°C		-	11.7	-	
- · IB1 - 0.2 A		@ 3 μs	@ T _C = 25°C		_	1.3	-	



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ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

	Symbol	Min	Тур	Max	Unit		
SWITCHING CHARACTE	RISTICS: Resistive Load (D.C.S. 10%,	Pulse Width = 40 μs	s)				
Turn-on Time	I _C = 0.4 Adc, I _{B1} = 40 mAdc	@ T _C = 25°C @ T _C = 125°C	t _{on}	- -	225 375	350 -	ns
Turn-off Time	I _{B2} = 200 mAdc V _{CC} = 300 Vdc	@ T _C = 25°C @ T _C = 125°C	t _{off}	0.8	- 1.5	1.1	μs
Turn-on Time	I _C = 1.0 Adc, I _{B1} = 0.2 Adc	@ T _C = 25°C @ T _C = 125°C	t _{on}	-	100 94	150 -	ns
Turn-off Time	I _{B2} = 0.5 Adc V _{CC} = 300 Vdc	@ T _C = 25°C @ T _C = 125°C	t _{off}	0.95 -	- 1.5	1.25 -	μs
SWITCHING CHARACTE	RISTICS: Inductive Load (V _{clamp} = 300	V, V _{CC} = 15 V, L = 2	200 μH)				,
Fall Time		@ T _C = 25°C @ T _C = 125°C	t _f	_	130 120	175 -	ns
Storage Time	$I_C = 0.4 \text{ Adc}$ $I_{B1} = 40 \text{ mAdc}$ $I_{B2} = 0.2 \text{ Adc}$	@ T _C = 25°C @ T _C = 125°C	t _s	0.4	- 0.7	0.7	μs
Cross-over Time	- B2	@ T _C = 25°C @ T _C = 125°C	t _c	- -	110 100	175 -	ns
Fall Time		@ T _C = 25°C @ T _C = 125°C	t _f	- -	130 140	175 -	ns
Storage Time	$I_{C} = 0.8 \text{ Adc}$ $I_{B1} = 160 \text{ mAdc}$ $I_{B2} = 160 \text{ mAdc}$	@ T _C = 25°C @ T _C = 125°C	t _s	2.1 -	3.0	2.4	μs
Cross-over Time		@ T _C = 25°C @ T _C = 125°C	t _c	-	275 350	350 -	ns
Fall Time		@ T _C = 25°C @ T _C = 125°C	t _f	-	100 100	150 -	ns
Storage Time	I _C = 1.0 Adc I _{B1} = 0.2 Adc I _{B2} = 0.5 Adc	@ T _C = 25°C @ T _C = 125°C	t _s	- -	1.05 1.45	1.2	μs
Cross-over Time	.02	@ T _C = 25°C @ T _C = 125°C	t _c	- -	100 115	150 -	ns



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TYPICAL STATIC CHARACTERISTICS

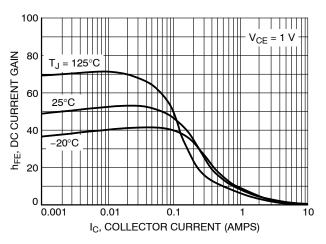


Figure 1. DC Current Gain @ 1 V

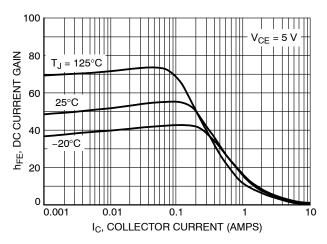


Figure 2. DC Current Gain @ 5 V

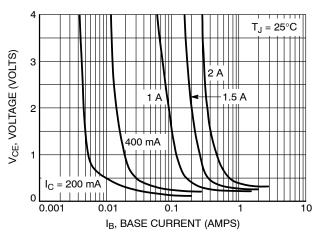


Figure 3. Collector Saturation Region

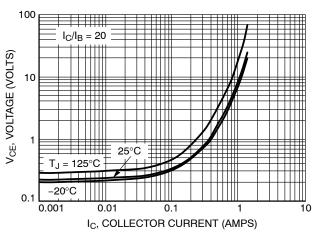


Figure 4. Collector-Emitter Saturation Voltage

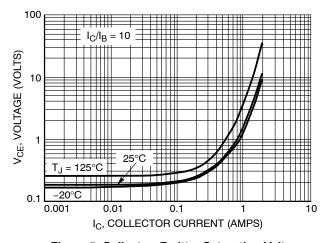


Figure 5. Collector-Emitter Saturation Voltage

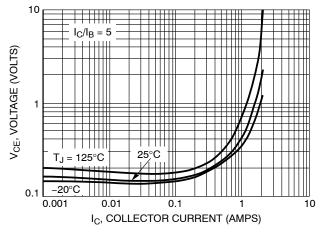


Figure 6. Collector-Emitter Saturation Voltage

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TYPICAL STATIC CHARACTERISTICS

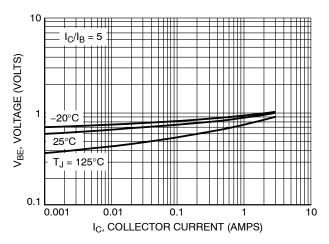


Figure 7. Base-Emitter Saturation Region $I_C/I_B = 5$

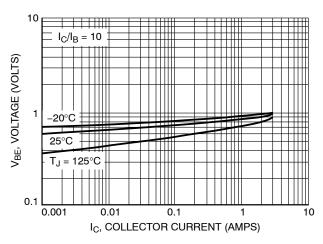


Figure 8. Base-Emitter Saturation Region $I_C/I_B = 10$

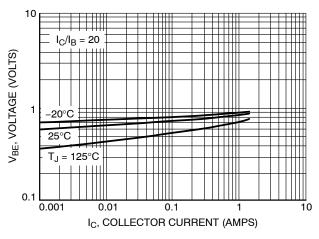


Figure 9. Base-Emitter Saturation Region $I_C/I_B = 20$

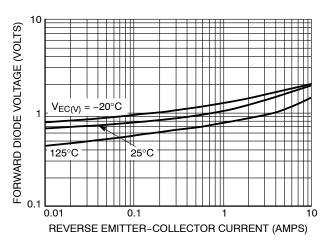


Figure 10. Forward Diode Voltage

TYPICAL SWITCHING CHARACTERISTICS

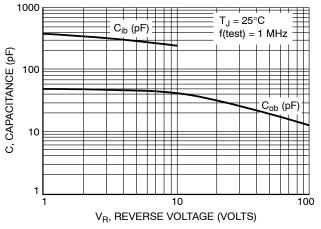


Figure 11. Capacitance

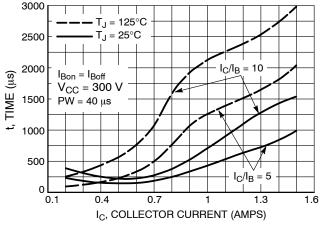


Figure 12. Resistive Switch Time, ton

TYPICAL SWITCHING CHARACTERISTICS

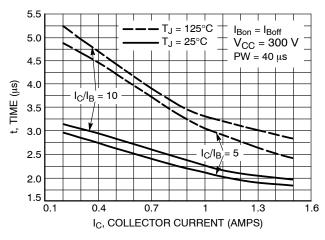


Figure 13. Resistive Switch Time, toff

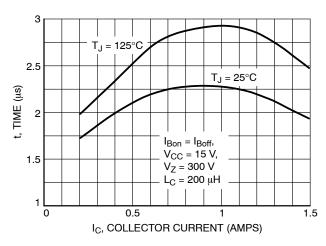


Figure 14. Inductive Storage Time, t_{si} @ I_C/I_B = 5

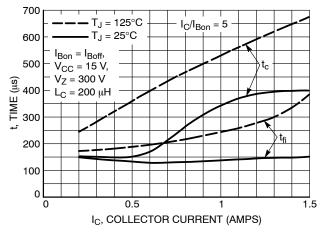


Figure 15. Inductive Switching, $t_c \& t_{fi} @ I_C/I_B = 5$

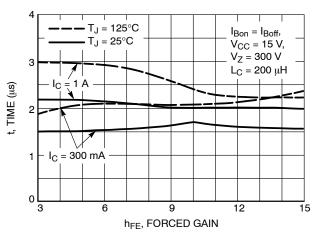


Figure 16. Inductive Storage Time

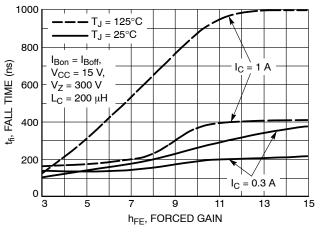


Figure 17. Inductive Fall Time

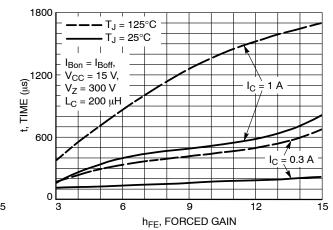


Figure 18. Inductive Cross-Over Time

TYPICAL SWITCHING CHARACTERISTICS

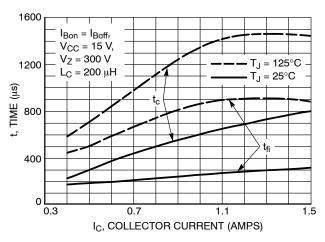


Figure 19. Inductive Switching Time, $t_{fi} \& T_C @ G = 10$

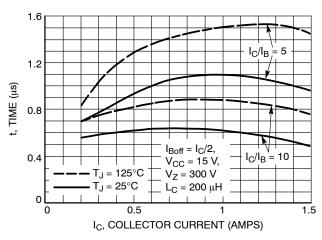


Figure 20. Inductive Switching Time, tsi

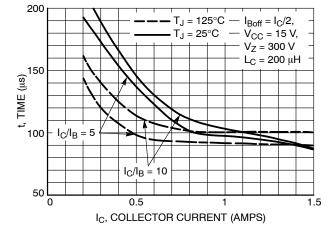


Figure 21. Inductive Storage Time, tfi

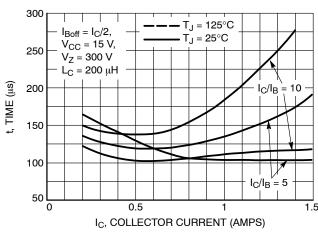


Figure 22. Inductive Storage Time, t_c

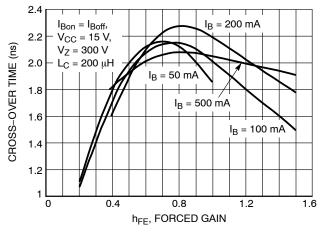


Figure 23. Inductive Storage Time, tsi

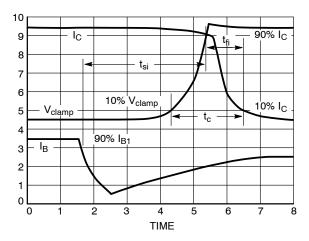
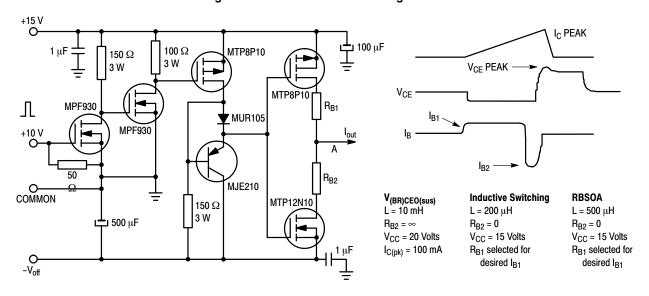


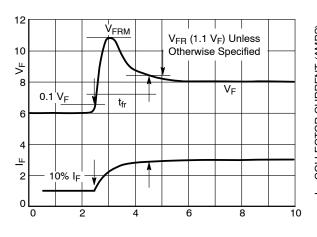
Figure 24. Inductive Switching Measurements

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Figure 25. Inductive Load Switching Drive Circuit





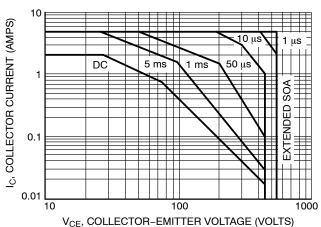
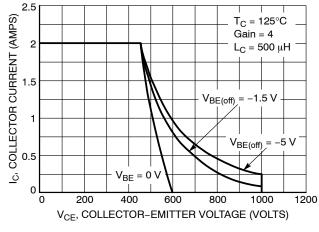
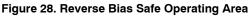


Figure 26. t_{fr} Measurement

Figure 27. Forward Bias Safe Operating Area





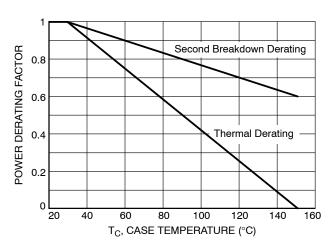


Figure 29. Forward Bias Power Derating

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There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C\text{--}V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate. The data of Figure 27 is based on $T_C=25^{\circ}C;\,T_{J(pk)}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when $T_C>25^{\circ}C.$ Second Breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown on

Figure 27 may be found at any case temperature by using the appropriate curve on Figure 29.

 $T_{J(pk)}$ may be calculated from the data in Figure 30. At any case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown. For inductive loads, high voltage and current must be sustained simultaneously during turn–off with the base to emitter junction reverse biased. The safe level is specified as a reverse biased safe operating area (Figure 28). This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode.

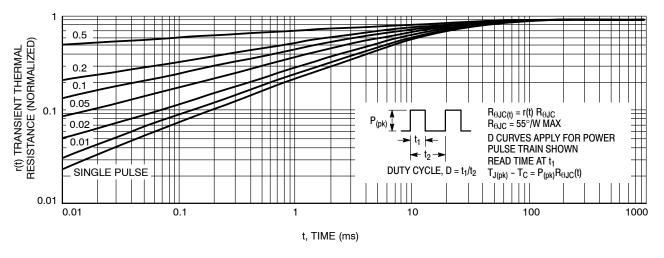


Figure 30. Typical Thermal Response (Z_{θJC}(t)) for MJD18002D2

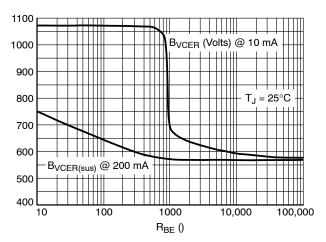


Figure 31. B_{VCER}

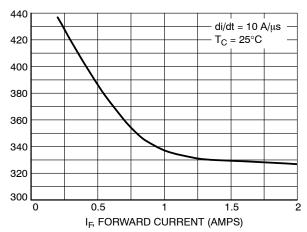


Figure 32. Forward Recovery Time, tfr



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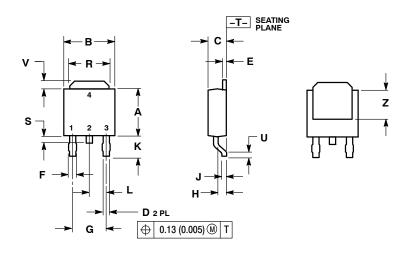
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PACKAGE DIMENSIONS

DPAK CASE 369C-01 **ISSUE B**



- OTES.

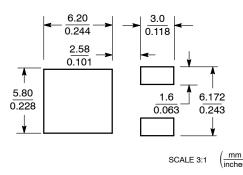
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: INCH.

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.235	0.245	5.97	6.22	
В	0.250	0.265	6.35	6.73	
С	0.086	0.094	2.19	2.38	
D	0.027	0.035	0.69	0.88	
Ε	0.018	0.023	0.46	0.58	
F	0.037	0.045	0.94	1.14	
G	0.180	BSC	4.58 BSC		
Н	0.034	0.040	0.87	1.01	
J	0.018	0.023	0.46	0.58	
Κ	0.102	0.114	2.60	2.89	
L	0.090	BSC	2.29 BSC		
R	0.180	0.215	4.57	5.45	
S	0.025	0.040	0.63	1.01	
U	0.020		0.51		
٧	0.035	0.050	0.89	1.27	
Z	0.155		3.93		

STYLE 1: PIN 1. BASE 2. COLLECTOR 3. EMITTER 4. COLLECTOR

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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